

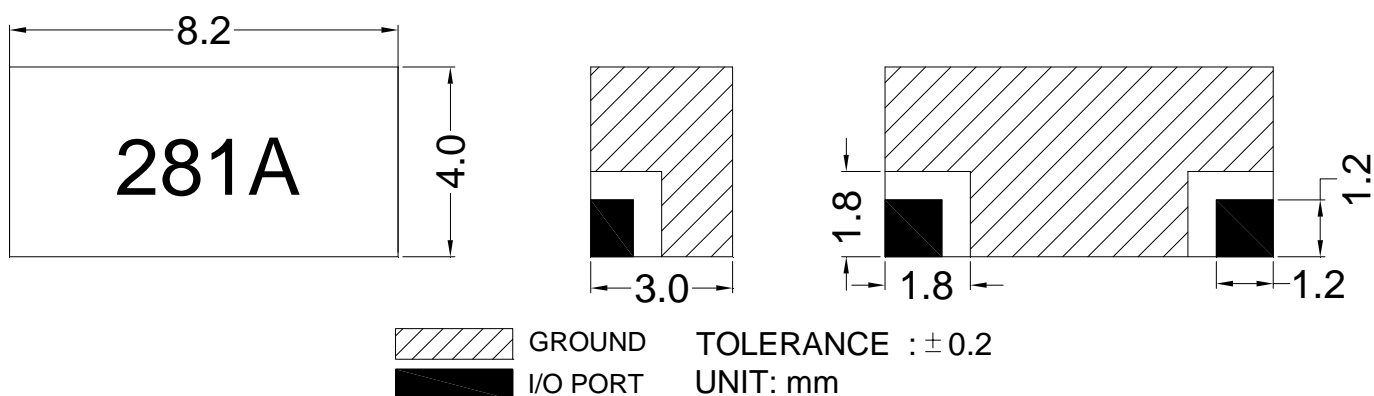
**FEATURES**

- Small Size,Light weight
- SMT package soldering
- Ideal for Microwave telecommunication

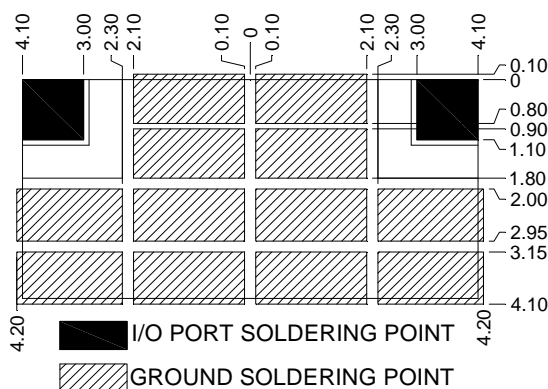
**SPECIFICATIONS**

NO.	ITEM	SPEC	UNIT
1	Center Frequency [fo]	5250.0	MHz
2	Bandwidth [BW]	fo±80	MHz
3	Insertion Loss in BW	2.3 max	dB
4	Ripple in BW	1.2 max	dB
5	VSWR in BW	1.67:1max	/
6	Attenuations	40min. @ 5490~5835 MHz	dB

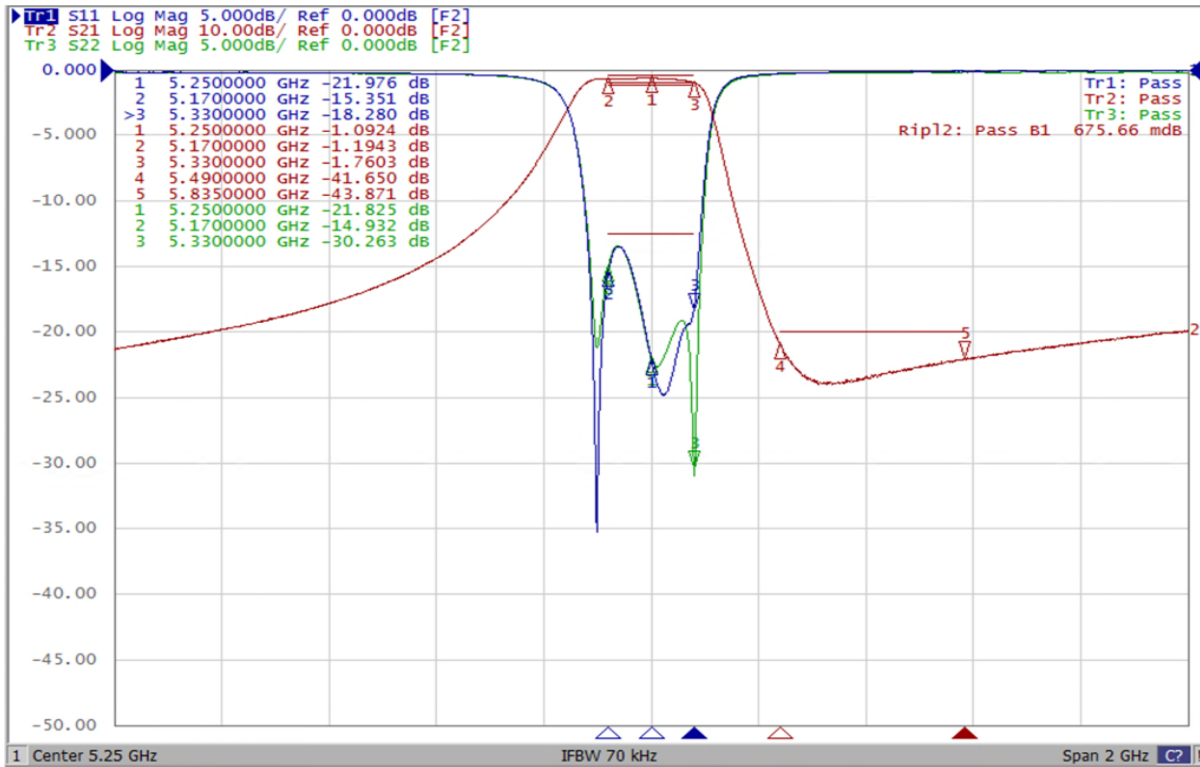
**OUTLINE DRAWING**



**FOOTPRINT**



**ELECTRICAL CHARACTERISTICS CURVE**



**ABSOLUTE MAXIMUM RATINGS**

<b>Operation Temperature</b>	-40°C to +85°C
<b>Storage Temperature</b>	-40°C to +85°C
<b>Input Power</b>	1 w max

**NOTES**

- RoHS 2.0/HSF
- Reflow soldering temperature curve

